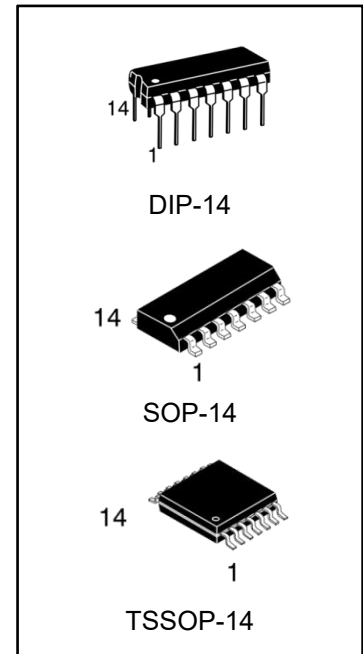


Cmos And Gate High-Voltage Types

Features

CD4073B and CD4082B AND Gates provide the system ed Inner with direct implementation of the AND function and supplement the existing family of CMOS gates.

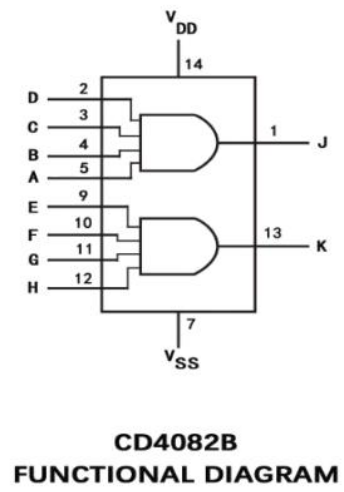
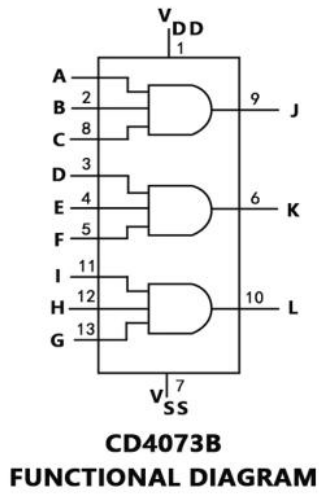
- Medium-Speed Operation - T_{PLH} , T_{PHL} =60ns (tsp.) at $V_{DD} = 10\text{ V}$
- 100% tested for quiescent current at 20V Maximum input current of $1\mu\text{A}$ at 18 V over full pack-temperature range, 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range)
 - 1V at $V_{DD}=5\text{V}$
 - 2V at $V_{DD}=10\text{V}$
 - 2.5V at $V_{DD}=15\text{V}$
- Standardized, symmetrical output characteristics
- 5V、10V and 15V parametric ratings
- Meets all requirements of JEDEC Tentative Tankard No.13B, Standard Specifications



Ordering Information

DEVICE	Package Type	MARKING	Packing	Packing Qty
CD4073BE/ CD4073BN	DIP-14	CD4073B	TUBE	1000pcs/box
CD4073BM/TR	SOP-14	CD4073B	REEL	2500pcs/reel
CD4073BMT/TR	TSSOP-14	CD4073B	REEL	2500pcs/reel
CD4082BE/ CD4082BN	DIP-14	CD4082B	TUBE	1000pcs/box
CD4082BM/TR	SOP-14	CD4082B	REEL	2500pcs/reel
CD4082BMT/TR	TSSOP-14	CD4082B	REEL	2500pcs/reel

Logic Diagram



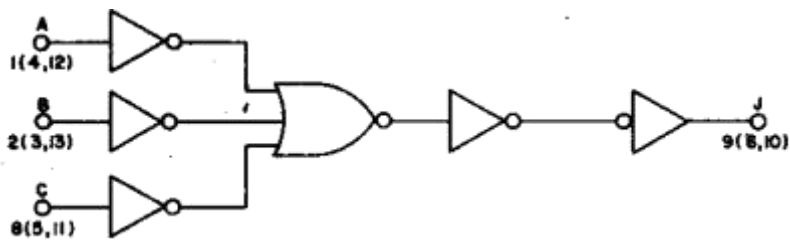
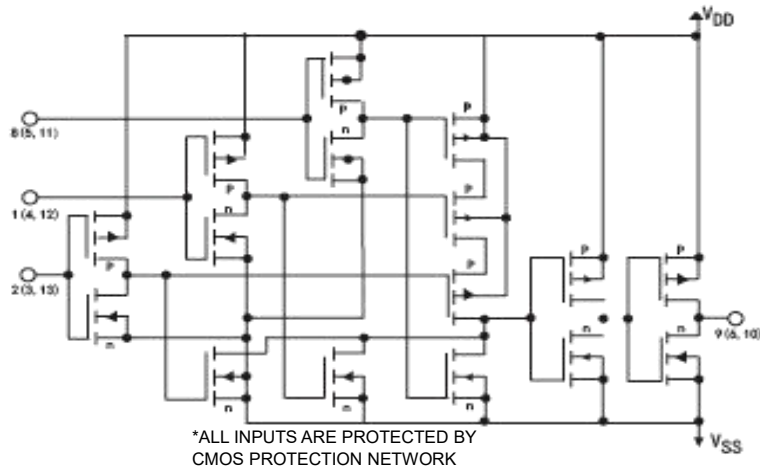


Fig.1 - Logic diagram for CD4073B(1 of 3 identical Gates).

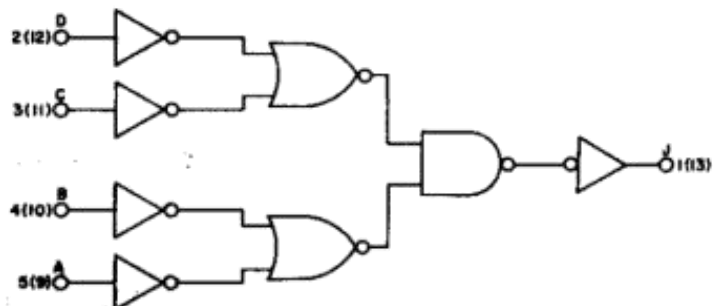
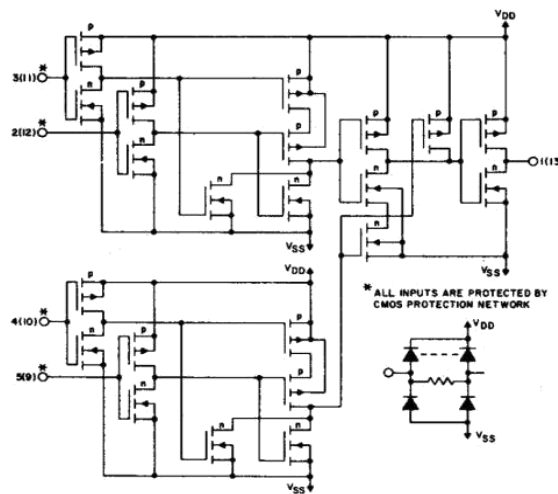
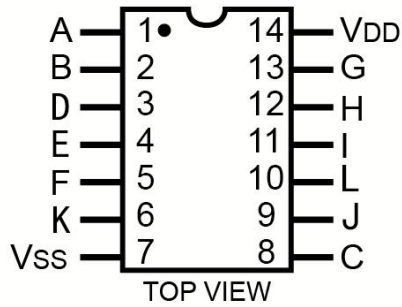
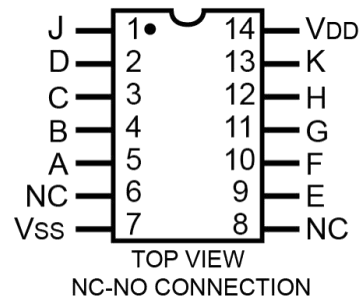


Fig.2 - Logic diagram for CD4082B (1 of 2 identical gates).

Pin Configuration



DIP/SOP/TSSOP
CB4073B



DIP/SOP/TSSOP
CB4082B

Maximum Ratings, Absolute-Maximum Values:

Condition	Min	Max	Units
DC SUPPLY-VOLTAGE RANGE,(VDD):			
Voltages reference to VSS Terminal)	-0.5	+20	V
INPUT VOLTAGE RANGE,ALLINPUTS	-0.5	+0.5	V
DC INPUT CURRENTANY ONE INPUT	-	+10	mA
POWER DISSIPATION PER PACKAG-(PD):			
For TA=55°C to +100°C	-	500	mA
For TA=+100°C to +125°C (Derate Linearity at)	12	200	mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR:			
FOR TA-FULL PACKAGE=TEMPERATURE RANGE(AI Pakage Types)	-	100	mW
OPERATING-TEMPERATURE RANGE(TA)	-40	+85	°C
STORAGE TEMPERATURE RANGE(stag)	-65	+150	°C
At distance 1/16±1/32inch(1.59+0.79mm)from case for 10s max	-	+245	°C

Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured.

Recommended operating conditions

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range (for T=Full Package Temperature Range)	5	15	V

Dynaic Electrical Charactetistics

at TA=25°C, Input tr, ft=20ns, and CL=50 pf, RL=200KΩ

CHARACTERISTIC	TEST CONDITIOS		ALL TYPES LIMITS		UNITS
		VDD Volts	TYP.	MAX.	
Propagation Delay Time,TPHL,TPLH		5	125	250	NS
		10	60	120	
		15	40	90	
Transition Time, TPHL,TPLH		5	100	200	NS
		10	50	100	
		15	40	80	
Input Capacitance,CIN	Any Input	-	5	7.5	Pf

Static Electrical Characteristics

CHARACTER. ISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES(°C)					UNITS
	VO (V)	VIN (V)	VDD (V)	+25					
				-40	+85	Min	TYP	MAX	
Quiescent Device Current,IDD Max.	-	0.5	5	0.25	7.5	-	0.01	0.25	μA
	-	0.10	10	0.5	15	-	0.01	0.5	
	-	0.15	15	1	30	-	0.01	1	
	-	0.20	20	5	150	-	0.02	5	
Output Low (Sink)Current IOL Min.	0.4	0.5	5	0.61	0.42	0.51	1	-	mA
	0.5	0.10	10	1.5	1.1	1.3	2.6	-	
	1.5	0.15	15	4	2.8	3.4	6.8	-	
Output High (Source) Current, IOH Min.	4.6	0.5	5	-0.61	-0.42	-0.51	-1	-	mA
	2.5	0.5	5	-1.8	-1.3	-1.6	-3.2	-	
	9.5	0.10	10	-1.5	-1.1	-1.3	-2.6	-	
Output Voltage Low-Level, VOL Max.	-	0.5	5	0.05		-	0	0.05	V
	-	0.10	10	0.05		-	0	0.05	
	-	0.15	15	0.05		-	0	0.05	
Output Voltage High-Level, VOH Min.	-	0.5	5	1.95		4.95	5	-	V
	-	0.10	10	9.95		9.95	10	-	
	-	0.15	15	14.95		14.95	15	-	
Input Low Voltage, VIL Max.	0.5	-	5	1.5		-	-	1.5	V
	1	-	10	3		-	-	3	
	1.5	-	15	4		-	-	4	
Input High Voltage, VIH Min.	0.5.4.5	-	5	3.5		3.5	-	-	V
	1.9	-	10	7		7	-	-	
	1.5.13.5	-	15	11		11	-	-	
Input Current VIN Max.		0.18	18	±0.1	±1	-	±10 ⁻⁵	±0.1	μA

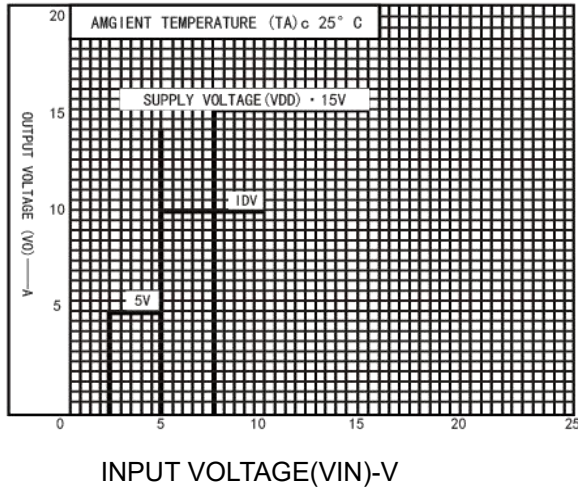


Fig.3-Typical voltage transfer characteristic.

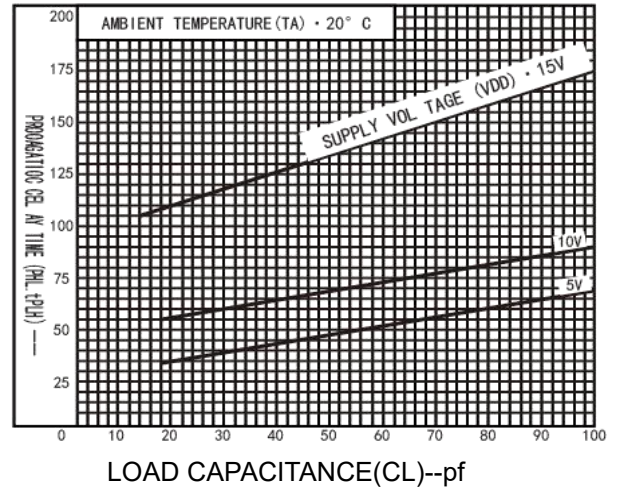


Fig.4 - Typical propagation delay time as a function of load capacitance.

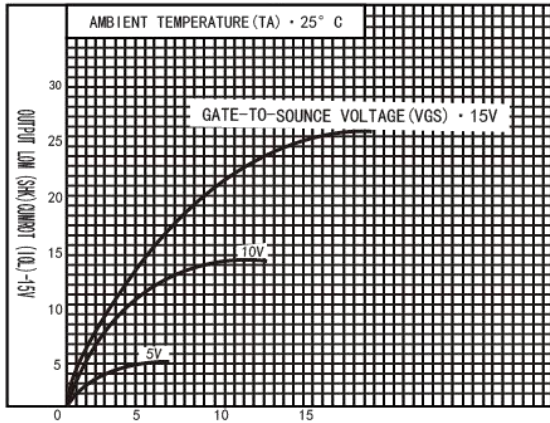


Fig.5 - Typical output low (sink) Current characteristics.

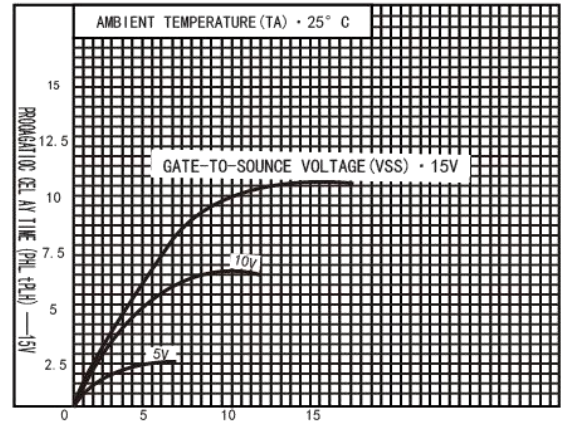


Fig.6 - Minimum output low (sink) Current characteristics.

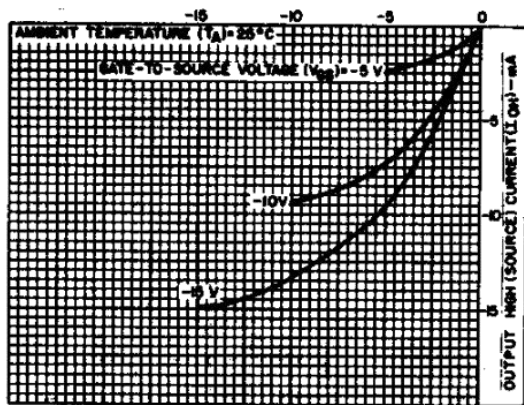


Fig.7 - Minimum output high (source) current characteristics

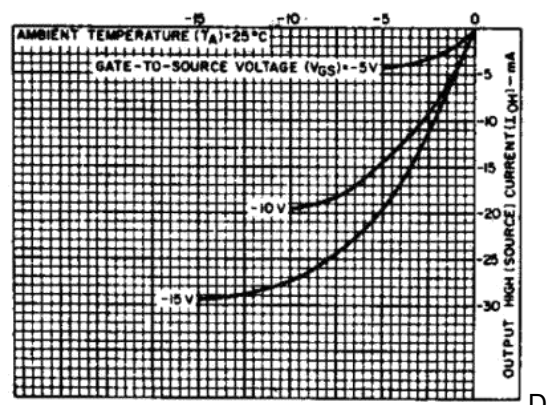


Fig.8 - Typical output high (source) current characteristics.

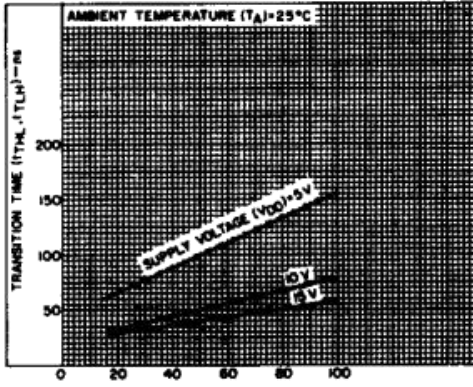


Fig.9 -Typical transition time as a function of load capacitance

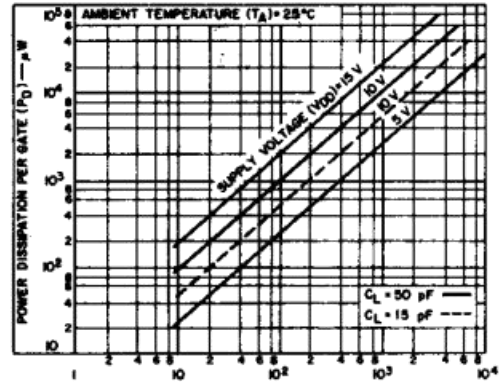


Fig.10 -Typical dynamic power dissipation per gate as a function of load capacitance

Terminal Assignments

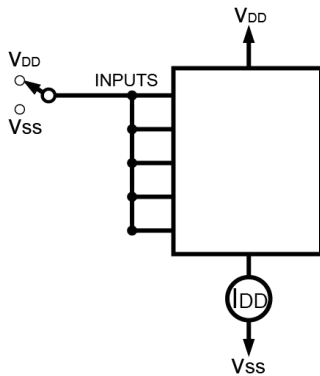


Fig.11 - Quiescent device current test circuit.

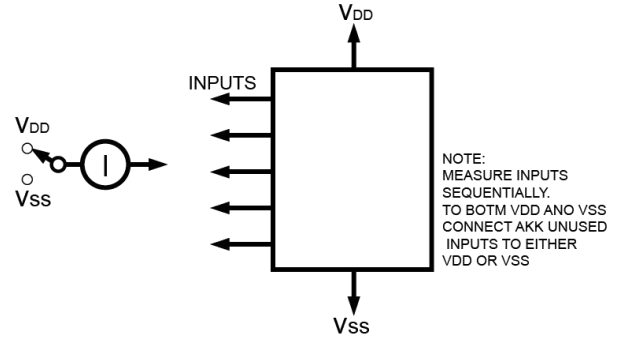


Fig.12 - Input current test circuit.

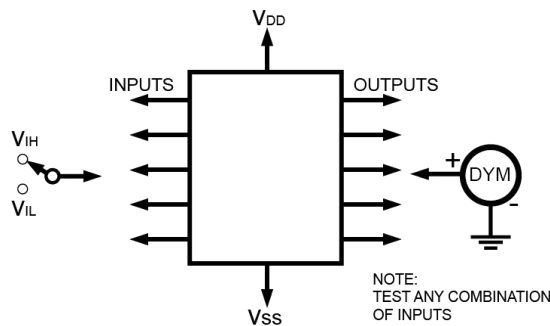
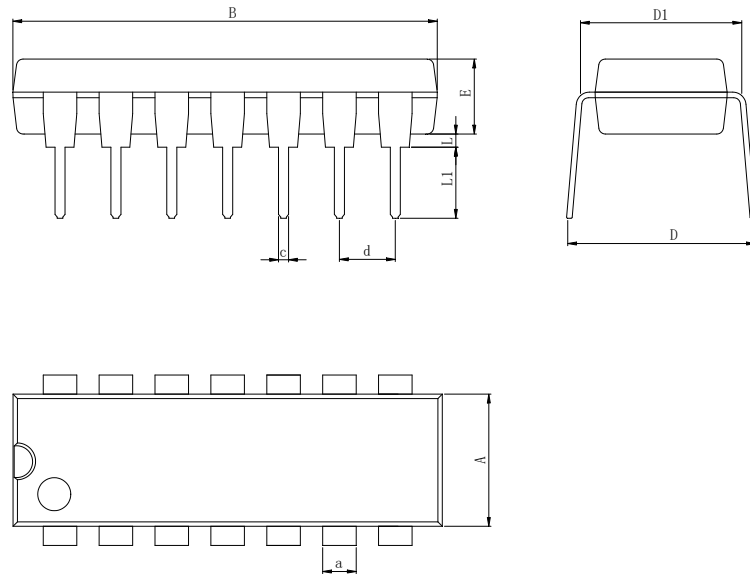


Fig.13 - Input-voltage test circuit.

Physical Dimensions

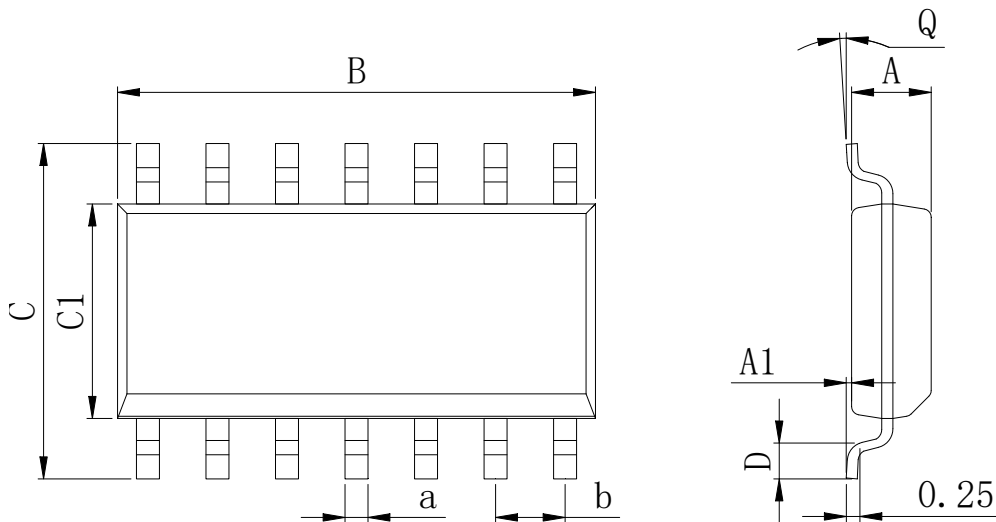
DIP-14



Dimensions In Millimeters(DIP-14)

Symbol:	A	B	D	D1	E	L	L1	a	c	d
Min:	6.10	18.94	8.10	7.42	3.10	0.50	3.00	1.50	0.40	2.54 BSC
Max:	6.68	19.56	10.9	7.82	3.55	0.70	3.60	1.55	0.50	

SOP-14

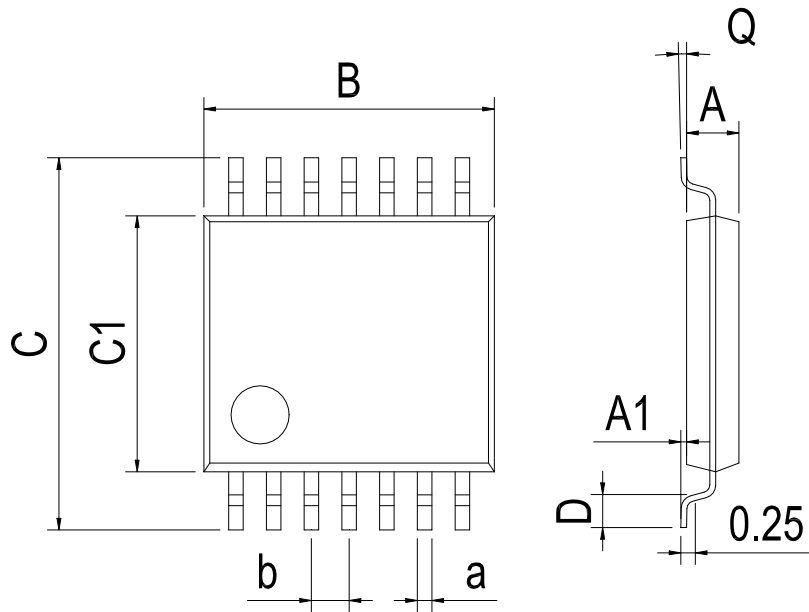


Dimensions In Millimeters(SOP-14)

Symbol:	A	A1	B	C	C1	D	Q	a	b
Min:	1.35	0.05	8.55	5.80	3.80	0.40	0°	0.35	1.27 BSC
Max:	1.55	0.20	8.75	6.20	4.00	0.80	8°	0.45	

Physical Dimensions

TSSOP-14



Dimensions In Millimeters(TSSOP-14)									
Symbol:	A	A1	B	C	C1	D	Q	a	b
Min:	0.85	0.05	4.90	6.20	4.30	0.40	0°	0.20	0.65 BSC
Max:	0.95	0.20	5.10	6.60	4.50	0.80	8°	0.25	

Revision History

DATE	REVISION	PAGE
2019-12-5	New	1-11
2023-11-14	Update Lead Temperature、 Update encapsulation type、 Updated DIP-14 dimension、 Add annotation for Maximum Ratings、 Update DIP Package New Model	1、 4、 8

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